

HD74LV1G125A

Bus Buffer Gate with 3-state Output

REJ03D0071-0600Z (Previous ADE-205-323D (Z)) Rev.6.00 Sep.01.2003

Description

The HD74LV1G125A has a bus buffer gate with 3–state output in a 5 pin package. Output is disabled when the associated output enable (\overline{OE}) input is high. To ensure the high impedance state during power up or power down, \overline{OE} should be connected to V_{CC} through a pull-down resistor; the minimum value of the resistor is determined by the current souring capability of the driver. Low voltage and high-speed operation is suitable for the battery powered products (e.g., notebook computers), and the low power consumption extends the battery life.

Features

- The basic gate function is lined up as Renesas uni logic series.
- Supplied on emboss taping for high-speed automatic mounting.
- Electrical characteristics equivalent to the HD74LV125A

Supply voltage range: 1.65 to 5.5 V

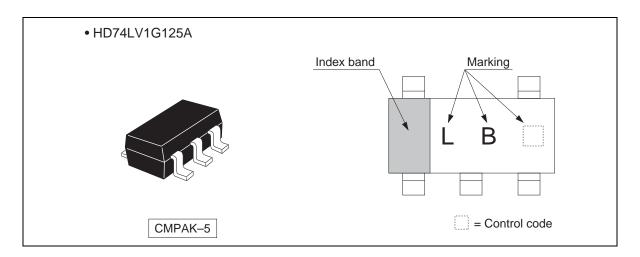
Operating temperature range : -40 to $+85^{\circ}C$

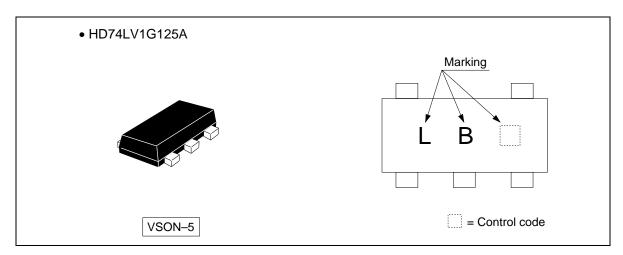
- All inputs V_{IH} (Max.) = 5.5 V (@ V_{CC} = 0 V to 5.5 V)
 - All outputs V_O (Max.) = 5.5 V (@ V_{CC} = 0 V, Output : Z)
- Output current ± 6 mA (@V_{CC} = 3.0 V to 3.6 V), ± 12 mA (@V_{CC} = 4.5 V to 5.5 V)
- All the logical input has hysteresis voltage for the slow transition.
- Ordering Information

Part Name	Package Type	Package Code	Package Abbreviation	Taping Abbreviation (Quantity)
HD74LV1G125ACME	CMPAK-5 pin	CMPAK-5V	CM	E (3,000 pcs/reel)
		CMPAK-5V(O)	_	
HD74LV1G125AVSE	VSON-5 pin	TNP-5DV	VS	_

Note: Please consult the sales office for the above package availability.

Outline and Article Indication



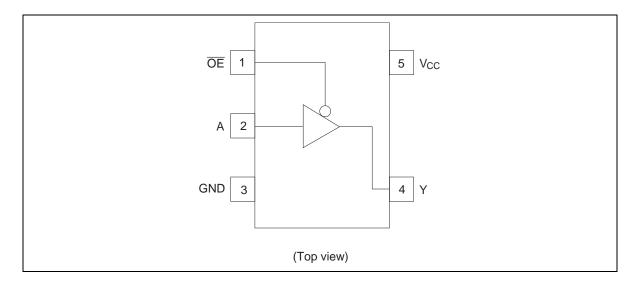


Function Table

Inputs		Output Y				
ŌĒ	Α					
L	Н	Н				
L	L	L				
Н	X	Z				

H: High level
L: Low level
X: Immaterial
Z: High impedance

Pin Arrangement



Absolute Maximum Ratings

Item	Symbol	Ratings	Unit	Test Conditions
Supply voltage range	V_{CC}	-0.5 to 7.0	V	
Input voltage range *1	VI	-0.5 to 7.0	V	
Output voltage range *1, 2	Vo	-0.5 to $V_{CC} + 0.5$	V	Output : H or L
		-0.5 to 7.0		V _{CC} : OFF or Output : Z
Input clamp current	I _{IK}	-20	mA	V _I < 0
Output clamp current	I _{OK}	±50	mA	$V_O < 0$ or $V_O > V_{CC}$
Continuous output current	Io	±25	mA	$V_{O} = 0$ to V_{CC}
Continuous current through V _{CC} or GND	I _{CC} or I _{GND}	±50	mA	
Maximum power dissipation at Ta = 25°C (in still air) *3	P _T	200	mW	
Storage temperature	Tstg	-65 to 150	°C	

Notes: The absolute maximum ratings are values, which must not individually be exceeded, and furthermore no two of which may be realized at the same time.

- 1. The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
- 2. This value is limited to 5.5 V maximum.
- 3. The maximum package power dissipation was calculated using a junction temperature of 150°C.

HD74LV1G125A

Recommended Operating Conditions

Item	Symbol	Min	Max	Unit	Conditions
Supply voltage range	V _{CC}	1.65	5.5	V	
Input voltage range	VI	0	5.5	V	
Output voltage range	Vo	0	Vcc	V	
		0	5.5		Output : Z
Output current	I _{OL}	_	1	mA	$V_{CC} = 1.65 \text{ to } 1.95 \text{ V}$
		_	2		$V_{CC} = 2.3 \text{ to } 2.7 \text{ V}$
		_	6		$V_{CC} = 3.0 \text{ to } 3.6 \text{ V}$
		_	12		$V_{CC} = 4.5 \text{ to } 5.5 \text{ V}$
	Гон	_	-1		V _{CC} = 1.65 to 1.95 V
		_	-2		$V_{CC} = 2.3 \text{ to } 2.7 \text{ V}$
		_	-6		$V_{CC} = 3.0 \text{ to } 3.6 \text{ V}$
		_	-12		$V_{CC} = 4.5 \text{ to } 5.5 \text{ V}$
Input transition rise or fall rate	Δt / Δν	0	300	ns / V	$V_{CC} = 1.65 \text{ to } 1.95 \text{ V}$
		0	200		$V_{CC} = 2.3 \text{ to } 2.7 \text{ V}$
		0	100		$V_{CC} = 3.0 \text{ to } 3.6 \text{ V}$
		0	20		$V_{CC} = 4.5 \text{ to } 5.5 \text{ V}$
Operating free-air temperature	Ta	-40	85	°C	

Note: Unused or floating inputs must be held high or low.

Electrical Characteristic

• $Ta = -40 \text{ to } 85^{\circ}\text{C}$

Item	Symbol	V _{CC} (V) *	Min	Тур	Max	Unit	Test condition
Input voltage	V _{IH}	1.65 to 1.95	V _{CC} ×0.75	_	_	V	
		2.3 to 2.7	V _{CC} ×0.7	_	_	=	
		3.0 to 3.6	V _{CC} ×0.7	_	_	-	
		4.5 to 5.5	V _{CC} ×0.7	_	_	-	
	V _{IL}	1.65 to 1.95	_	_	V _{CC} ×0.25	-	
		2.3 to 2.7	_	_	V _{CC} ×0.3	-	
		3.0 to 3.6	_	_	V _{CC} ×0.3	-	
		4.5 to 5.5	_	_	V _{CC} ×0.3	-	
Hysteresis voltage	V _H	1.8	_	0.25	_	V	$V_T^+ - V_T^-$
		2.5	_	0.30	_	-	
		3.3	_	0.35	_	-	
		5.0	_	0.45	_	-	
Output voltage	V _{OH}	Min to Max	V _{CC} -0.1	_	_	V	$I_{OH} = -50 \mu A$
		1.65	1.4	_	_	-	$I_{OH} = -1 \text{ mA}$
		2.3	2.0	_	_	-	I _{OH} = -2 mA
		3.0	2.48	_	_	-	$I_{OH} = -6 \text{ mA}$
		4.5	3.8	_	_	-	$I_{OH} = -12 \text{ mA}$
	V _{OL}	Min to Max	_	_	0.1	-	I _{OL} = 50 μA
		1.65	_	_	0.3	-	I _{OL} = 1 mA
		2.3	_	_	0.4	-	I _{OL} = 2 mA
		3.0	_	_	0.44	-	I _{OL} = 6 mA
		4.5	_	_	0.55	-	I _{OL} = 12 mA
Input current	I _{IN}	0 to 5.5	_	_	±1	μΑ	$V_{IN} = 5.5 \text{ V or GND}$
Off state output current	loz	Min to Max	_	_	±5	μΑ	$V_0 = 5.5 \text{ V or GND}$
Quiescent supply current	Icc	5.5	_	_	10	μΑ	$V_{IN} = V_{CC}$ or GND, $I_O = 0$
Output leakage current	loff	0	_	_	5	μΑ	V_{IN} or $V_O = 0$ to 5.5 V
Input capacitance	C _{IN}	3.3	_	3.0	_	pF	$V_{IN} = V_{CC}$ or GND

Note: For conditions shown as Min or Max, use the appropriate values under recommended operating conditions.

Switching Characteristics

• $V_{CC} = 1.8 \pm 0.15 \text{ V}$

Item	Symbol $Ta = 25^{\circ}C$ $Ta = -40 \text{ to } 85^{\circ}C$		Unit		FROM	ТО				
		Min	Тур	Max	Min	Max	_	Conditions	(Input)	(Output)
Propagation	t _{PLH}	_	13.5	23.5	1.0	26.0	ns	C _L = 15 pF	Α	Υ
delay time	t _{PHL}	_	19.0	33.0	1.0	36.0	-	C _L = 50 pF	_	
Enable time	t_{ZH}	_	13.7	26.5	1.0	29.0	ns	C _L = 15 pF	ŌĒ	Υ
	t_{ZL}	_	20.5	36.0	1.0	38.0	-	C _L = 50 pF	_	
Disable time	t _{HZ}	_	8.3	20.0	1.0	22.5	ns	C _L = 15 pF	ŌĒ	Υ
	t_{LZ}	_	13.0	29.5	1.0	32.0	-	C _L = 50 pF	_	

$\bullet \quad V_{CC} = 2.5 \pm 0.2 \ V$

Item	Symbol Ta = 25°C			Ta = -	40 to 85°C	Unit		FROM	ТО	
		Min	Тур	Max	Min	Max	_	Conditions	(Input)	(Output)
Propagation	t _{PLH}	_	6.8	13.0	1.0	15.5	ns	C _L = 15 pF	Α	Υ
delay time	t _{PHL}	_	8.7	16.5	1.0	18.5	=	C _L = 50 pF	_	
Enable time	t _{ZH}	_	7.0	13.0	1.0	15.5	ns	C _L = 15 pF	ŌĒ	Υ
	t_{ZL}	_	8.8	16.5	1.0	18.5	_	C _L = 50 pF	_	
Disable time	t _{HZ}	_	5.1	14.7	1.0	17.0	ns	C _L = 15 pF	ŌĒ	Υ
	t_{LZ}	_	7.3	18.2	1.0	20.5	_	C _L = 50 pF		

$\bullet \quad V_{CC} = 3.3 \pm 0.3 \ V$

Item	Symbol	Ta = 1	25°C		Ta = -40 to 85°C				FROM	ТО
		Min	Тур	Max	Min	Max	_	Conditions	(Input)	(Output)
Propagation	t _{PLH}	_	4.8	8.0	1.0	9.5	ns	C _L = 15 pF	Α	Υ
delay time	t _{PHL}	_	6.1	11.5	1.0	13.0	=	C _L = 50 pF	_	
Enable time	t _{ZH}	_	4.8	8.0	1.0	9.5	ns	C _L = 15 pF	ŌĒ	Υ
	t_{ZL}	_	6.2	11.5	1.0	13.0	=	C _L = 50 pF	_	
Disable time	t _{HZ}	_	4.1	9.7	1.0	11.5	ns	C _L = 15 pF	ŌĒ	Υ
	t_{LZ}	_	5.5	13.2	1.0	15.0		C _L = 50 pF	_	

Switching Characteristics (cont)

 $\bullet \quad V_{CC} = 5.0 \pm 0.5 \ V$

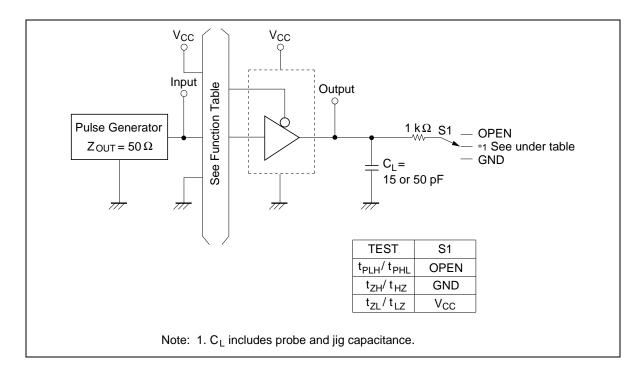
Item	Symbol	Ta = 25°C			Ta = -40 to 85°C		Unit		FROM	TO
		Min	Тур	Max	Min	Max	_	Conditions	(Input)	(Output)
Propagation	t _{PLH}	_	3.4	5.5	1.0	6.5	ns	C _L = 15 pF	Α	Υ
delay time	t _{PHL}	_	4.3	7.5	1.0	8.5	=	C _L = 50 pF	_	
Enable time	t _{ZH}	_	3.4	5.1	1.0	6.0	ns	C _L = 15 pF	ŌĒ	Υ
	t_{ZL}	_	4.4	7.1	1.0	8.0	=	C _L = 50 pF	_	
Disable time	t _{HZ}	_	3.2	6.8	1.0	8.0	ns	C _L = 15 pF	ŌĒ	Υ
	t_{LZ}	_	4.0	8.8	1.0	10.0		C _L = 50 pF	_	

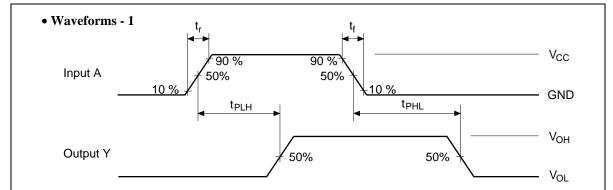
Operating Characteristics

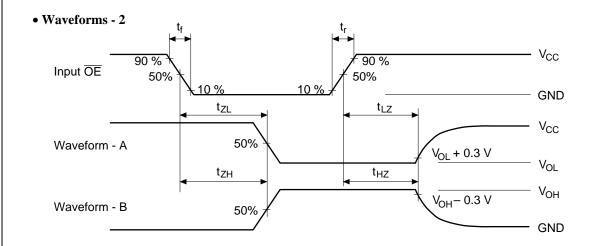
• $C_L = 50 pF$

Item	Symbol	V _{CC} (V)	Ta = 25°C			Unit	Test Conditions
			Min	Тур	Max	_	
Power dissipation	C_{PD}	3.3	_	10.5	_	pF	f = 10 MHz
capacitance		5.0		11.5	_		

Test Circuit



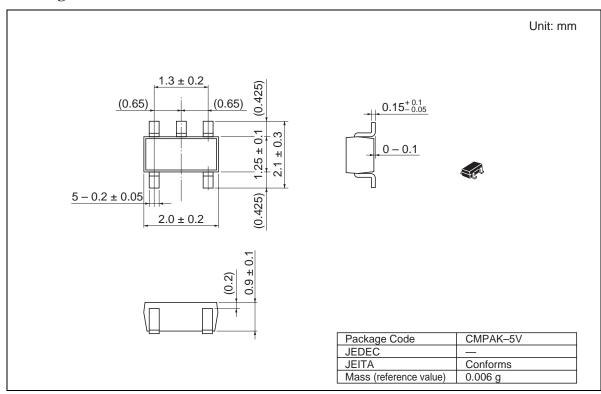


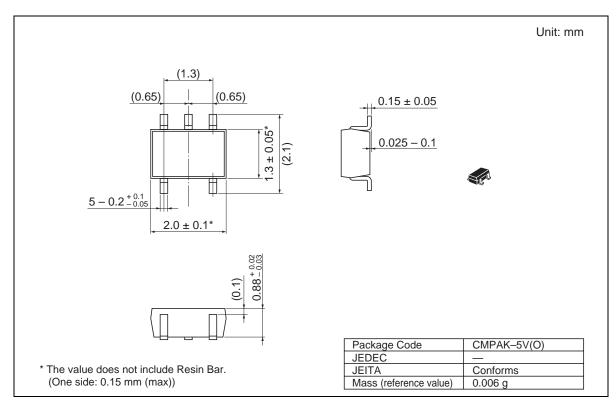


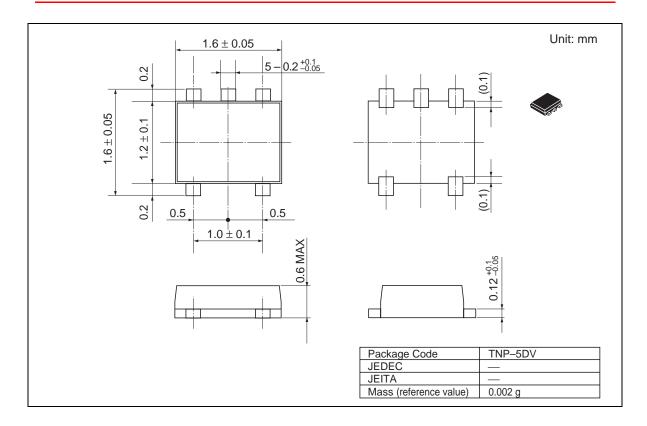
Notes: 1. Input waveform : PRR \leq 1 MHz, Zo = 50 Ω , $t_r \leq$ 3 ns, $t_f \leq$ 3 ns.

- 2. Waveform A is for an output with internal conditions such that the output is low except when disabled by the output control.
- 3. Waveform B is for an output with internal conditions such that the output is high except when disabled by the output control.
- 4. The output are measured one at a time with one transition per measurement.

Package Dimensions







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